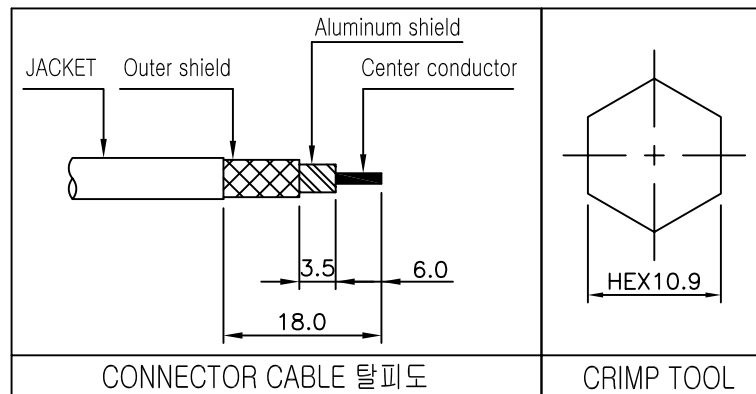
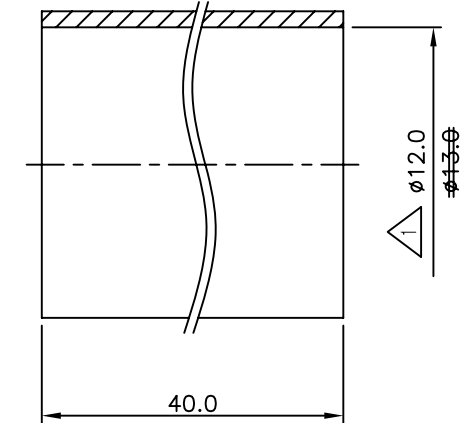
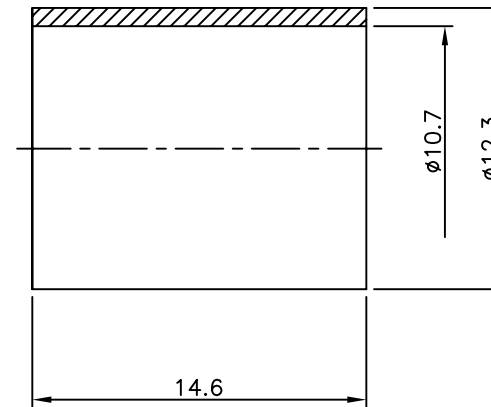
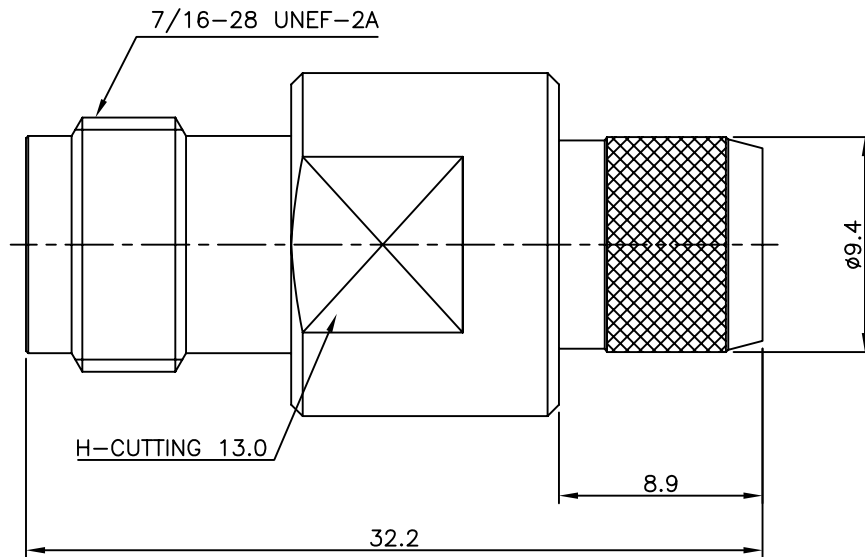
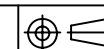


REVISION				
REV	DESCRIPTION	DRAWN	APPR	DATE
IR	Initial Registration	S.Y.EUN	I.C.KIM	2019.04.02.
1	생산팀 요청으로 인한 본딩튜브 사이즈 변경 (Ø13 → Ø12)	S.Y.EUN	I.C.KIM	2021.02.24.



7	BONDING TUBE	1	—	—	ATU00012-N/1 ATU00013-N/1
6	INSULATOR	1	TEFLON		DIN02609-N/2
5	GASKET	1	SILICONE Rub		DGK00219-N/1
4	FERRULE	1	MBsBD C3604BD-F	Nickel Plate	DFE00076-5/1
3	CONTACT	1	BeCu C17300	Gold Plate	DCT04006-5/1
2	BODY (B)	1	MBsBD C3604BD-F	Nickel Plate	DBD04477-5/1
1	BODY (A)	1	MBsBD C3604BD-F	Nickel Plate	DBD04476-5/1
NO.	DESCRIPTION	Q'TY	MATERIAL	PLATING	CODE

TOLERANCE	Decimal	DATE 2021. 02. 24.		 RF & MICROWAVE TECHNOLOGY Tel : 82-32-347-8015 Fax : 82-32-347-8017
	Angle	APPROVED BY	I.C.KIM	
MATERIAL		CHECKED BY		KJ COMTECH CO.,LTD. TITLE TNC50 CABLE JS LMR400
		DRAWN BY	S.Y.EUN	
FINISH		SCALE	3/1	DWG NO. CN03830-7/1 REVISION 1 SHEET 1 of 1
		UNIT	mm	



A4